



TG-S606P

Thermal Compound

Version 2.300719



Thermal Compound

TG-S606P is an ultra high performance silicone grease. It has a thermal conductivity of 8 W/mK, superior wetting characteristics, resulting in a very low thermal resistance and excellent long term reliability.

Features

- Good thermal conductivity
- Easy to assemble
- High stability
- Does not harden with time

Applications

Electronic components: IC, CPU, MOS
 LED, M/B, P/S, Heat Sink
 LCD TV, Notebook PC, PC Telecom Device, Wireless Hub, etc.
 DDR II Module, DVD Applications, Hand-set applications, etc.

Properties

- ✓ REACH Compliant
- ✓ ROHS Compliant

Property	TG-S606P	Unit	Test Method
Colour	White	-	Visual
Thermal Conductivity	8.0	W/mK	ASTM D5470
Weight Loss	<0.5	%	ASTM E595
Density	2.3	g/cm ³	ASTM D792
Working Temperature	-40 to 180	°C	-
Volume Resistance	>10 ¹²	Ohm-cm	ASTM D257

Standard Packaging

Size	Packaging	Weight (gr)
	Syringe	30 g
Syringe	50 g	
Pot	100 g	
Pot	500 g	
Pail	1.0 kg	
Pail	1.5 kg	

Storage

TG-S606P has a self-life of eighteen (18) months from the date of manufacture, as indicated by the lot number, when stored in the original, unopened container at, or below 25°C.

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